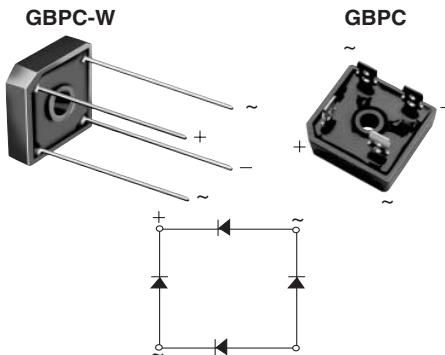


Glass Passivated Single-Phase Bridge Rectifier

Major Ratings and Characteristics

$I_{F(AV)}$	12 A, 15 A, 25 A, 35 A
V_{RRM}	50 V to 1000 V
I_{FSM}	200 A, 300 A, 300 A, 400 A
I_R	5 μ A
V_F	1.1 V
T_j max.	150 °C



Features

- UL Recognition file number E54214
- Universal 3-way terminals: snap-on, wire wrap-around, or P.C.B. mounting
- Typical I_R less than 0.3 μ A
- High surge current capability
- Low thermal resistance
- Solder Dip 260 °C, 40 seconds



Mechanical Data

Case: GBPC, GBPC-W

Epoxy meets UL-94V-0 Flammability rating

Terminals: Nickel plated on faston lugs or Silver plated on wire leads (E4 Suffix), solderable per J-STD-002B and JESD22-B102D. Suffix letter "W" added to indicate wire leads (e.g. GBPC12005W)

Polarity: As marked, Positive lead by beveled corner

Mounting Torque: 20 inches-lbs. max.

Typical Applications

General purpose use in ac-to-dc bridge full wave rectification for Power Supply, Home Appliances, Office Equipment, Industrial Automation applications

Maximum Ratings

Ratings at 25 °C ambient temperature unless otherwise specified.

Parameter	Symbols	GBPC12, 15, 25, 35							Units
		005	01	02	04	06	08	10	
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified output current (See Fig.1)	$I_{F(AV)}$			12					A
				15					
				25					
				35					
Peak forward surge current single sine-wave superimposed on rated load	I_{FSM}			200					A
				300					
				300					
				400					
Rating (non-repetitive, for t greater than 1 ms and less than 8.3 ms) for fusing	I^2t			160					$A^2 \text{ sec}$
				375					
				375					
				660					
RMS isolation voltage from case to leads	V_{ISO}			2500					V
Operating junction storage temperature range	T_J, T_{STG}			- 55 to + 150					°C

GBPC12, 15, 25 and 35



Vishay Semiconductors

Electrical Characteristics

Ratings at 25 °C ambient temperature unless otherwise specified.

Parameter	Test condition	Symbols	GBPC12, 15, 25, 35							Units
			005	01	02	04	06	08	10	
Maximum instantaneous forward drop per leg	GBPC12 GBPC15 GBPC25 GBPC35	$I_F = 6.0 \text{ A}$ $I_F = 7.5 \text{ A}$ $I_F = 12.5 \text{ A}$ $I_F = 17.5 \text{ A}$	V_F	1.1						
Maximum reverse DC current at rated DC blocking voltage per leg	$T_A = 25 \text{ }^\circ\text{C}$ $T_A = 125 \text{ }^\circ\text{C}$	I_R	5.0 500							μA
Typical junction capacitance per leg	at 4 V, 1 MHz	C_J	300							pF

Thermal Characteristics

Ratings at 25 °C ambient temperature unless otherwise specified.

Parameter	Symbols	GBPC12, 15, 25, 35							Units
		005	01	02	04	06	08	10	
Typical thermal resistance per leg ⁽¹⁾	$R_{\theta JC}$	1.9 1.4							°C/W

Notes:

(1) Thermal resistance from junction to case per leg

(2) Bolt down on heatsink with silicone thermal compound between bridge and mounting surface for maximum heat transfer with #10 screw

Ratings and Characteristics Curves

($T_A = 25 \text{ }^\circ\text{C}$ unless otherwise noted)

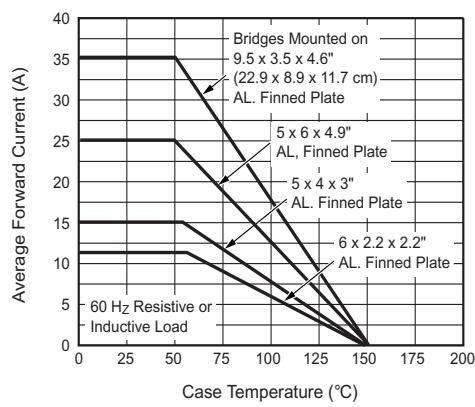


Figure 1. Maximum Output Rectified Current

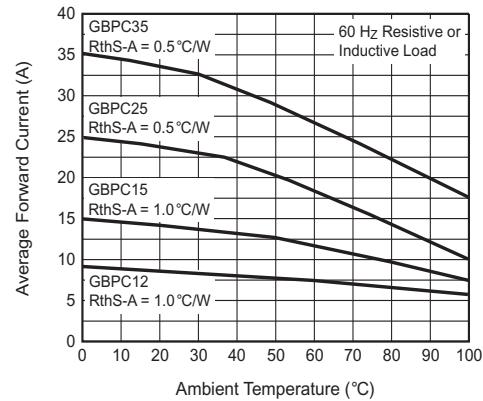


Figure 2. Maximum Output Rectified Current

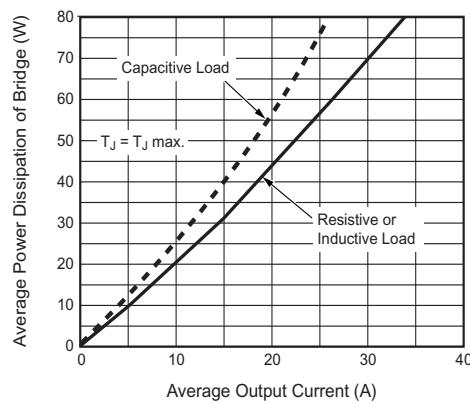


Figure 3. Maximum Power Dissipation

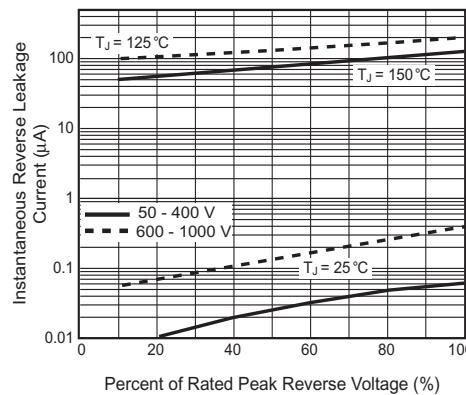


Figure 6. Typical Reverse Leakage Characteristics Per Leg

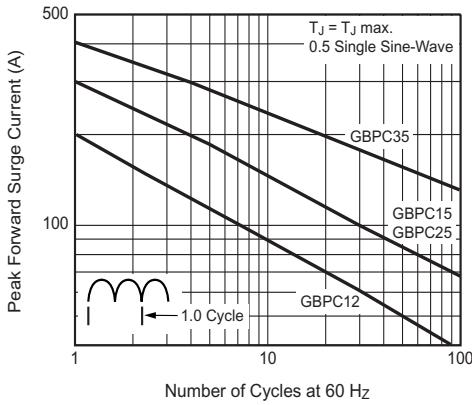


Figure 4. Maximum Non-Repetitive Peak Forward Surge Current Per Leg

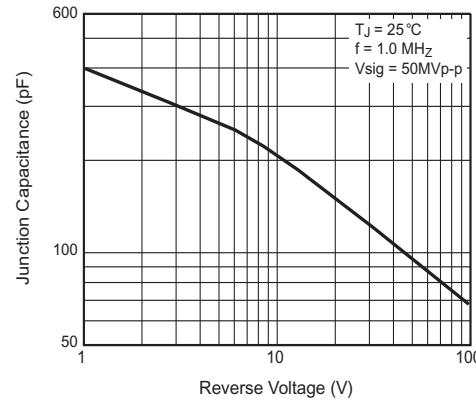


Figure 7. Typical Junction Capacitance Per Leg

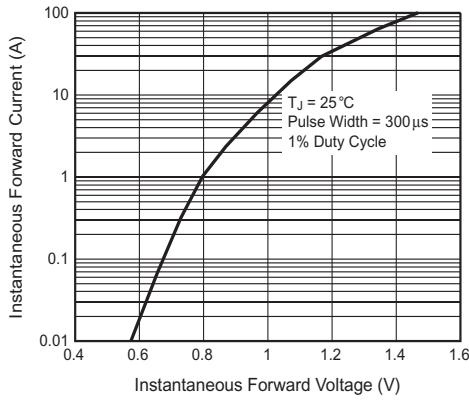


Figure 5. Typical Instantaneous Forward Characteristics Per Leg

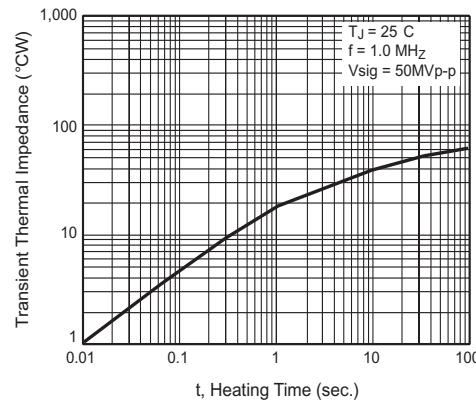


Figure 8. Typical Transient Thermal Impedance Per Leg

GBPC12, 15, 25 and 35

Vishay Semiconductors



Package outline dimensions in inches (millimeters)

